

Appl. No. 10/695,630
Amdt. dated March 15, 2006
Reply to Office action of December 15, 2005

AMENDMENTS

IN THE SPECIFICATION

Please replace the title with the following title:

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CHIP PACKAGE WITH MULTIPLE CHIPS CONNECTED BY BUMPS

Please amend the following paragraph under the section labeled, CROSS-REFERENCE TO RELATED REFERENCE.

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This application claims the priority benefit of Taiwan application serial no. 91125126, filed on October 25, 2002. This application is related to application No. 09/798,654 filed on Mar. 5, 2001, now Pat. No. 6,818,545; and related to application No. 10/935,451 filed on Sep. 7, 2004, now pending; and related to application No. 09/953,525 filed on Sep. 17, 2001, now Pat. No. 6,642,136; and related to application No. 10/638,454 filed on Aug. 11, 2003, now Pat. No. 6,917,119; and related to application No. 11/120,234 filed on May 2, 2005, now pending; and related to application No. 09/837,007 filed on Apr. 18, 2001, now pending; and related to application No. 10/055,580 filed on Jan. 22, 2002, now pending; and related to application No. 10/174,357 filed on Jun. 17, 2002, now Pat. No. 6,784,087; and related to application No. 10/874,704 filed on Oct. 27, 2003, now pending; and related to application No. 11/123,328 filed on May 6, 2005, now pending, all assigned to a common assignee.

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